

SN74ALVCHR162269A

12-BIT TO 24-BIT REGISTERED BUS EXCHANGER WITH 3-STATE OUTPUTS

SCES050E – AUGUST 1995 – REVISED JULY 1997

- Member of the Texas Instruments **Widebus™** Family
- **EPIC™** (Enhanced-Performance Implanted CMOS) Submicron Process
- All Outputs Have Equivalent 26-Ω Series Resistors, So No External Resistors Are Required
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and 300-mil Shrink Small-Outline (DL) Packages

description

This 12-bit to 24-bit registered bus exchanger is designed for 2.3-V to 3.6-V V_{CC} operation.

The SN74ALVCHR162269A is used in applications where two separate ports must be multiplexed onto, or demultiplexed from, a single port. It is particularly suitable as an interface between synchronous DRAMs and high-speed microprocessors.

Data is stored in the internal B-port registers on the low-to-high transition of the clock (CLK) input when the appropriate clock enable (\overline{CLKENA}) inputs are low. Proper control of these inputs allows two sequential 12-bit words to be presented as a 24-bit word on the B port. For data transfer in the B-to-A direction, a single storage register is provided. The select (\overline{SEL}) line selects 1B or 2B data for the A outputs. The register on the A output permits the fastest possible data transfer, thus extending the period during which the data is valid on the bus. The control terminals are registered so that all transactions are synchronous with CLK. Data flow is controlled by the active-low output enables (\overline{OEA} , $\overline{OEB1}$, and $\overline{OEB2}$).

DGG, DGV, OR DL PACKAGE (TOP VIEW)

\overline{OEA}	1	56	$\overline{OEB2}$
$\overline{OEB1}$	2	55	$\overline{CLKENA2}$
2B3	3	54	2B4
GND	4	53	GND
2B2	5	52	2B5
2B1	6	51	2B6
V_{CC}	7	50	V_{CC}
A1	8	49	2B7
A2	9	48	2B8
A3	10	47	2B9
GND	11	46	GND
A4	12	45	2B10
A5	13	44	2B11
A6	14	43	2B12
A7	15	42	1B12
A8	16	41	1B11
A9	17	40	1B10
GND	18	39	GND
A10	19	38	1B9
A11	20	37	1B8
A12	21	36	1B7
V_{CC}	22	35	V_{CC}
1B1	23	34	1B6
1B2	24	33	1B5
GND	25	32	GND
1B3	26	31	1B4
NC	27	30	$\overline{CLKENA1}$
\overline{SEL}	28	29	CLK

NC – No internal connection



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description (continued)

To ensure the high-impedance state during power up or power down, a clock pulse should be applied as soon as possible and \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver. Due to \overline{OE} being routed through a register, the active state of the outputs cannot be determined prior to the arrival of the first clock pulse.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

All outputs are designed to sink up to 12 mA and include equivalent 26- Ω resistors to reduce overshoot and undershoot.

The SN74ALVCHR162269A is characterized for operation from -40°C to 85°C .

Function Tables

OUTPUT ENABLE

INPUTS			OUTPUTS	
CLK	\overline{OEA}	\overline{OEB}	A	1B, 2B
\uparrow	H	H	Z	Z
\uparrow	H	L	Z	Active
\uparrow	L	H	Active	Z
\uparrow	L	L	Active	Active

A-TO-B STORAGE ($\overline{OEB} = L$)

INPUTS				OUTPUTS	
$\overline{CLKENA1}$	$\overline{CLKENA2}$	CLK	A	1B	2B
L	H	\uparrow	L	L	$2B_0^{\dagger}$
L	H	\uparrow	H	H	$2B_0^{\dagger}$
L	L	\uparrow	L	L	L
L	L	\uparrow	H	H	H
H	L	\uparrow	L	$1B_0^{\dagger}$	L
H	L	\uparrow	H	$1B_0^{\dagger}$	H
H	H	X	X	$1B_0^{\dagger}$	$2B_0^{\dagger}$

\dagger Output level before the indicated steady-state input conditions were established

B-TO-A STORAGE ($\overline{OEA} = L$)

INPUTS				OUTPUT
CLK	\overline{SEL}	1B	2B	A
X	H	X	X	A_0^{\dagger}
X	L	X	X	A_0^{\dagger}
\uparrow	H	L	X	L
\uparrow	H	H	X	H
\uparrow	L	X	L	L
\uparrow	L	X	H	H

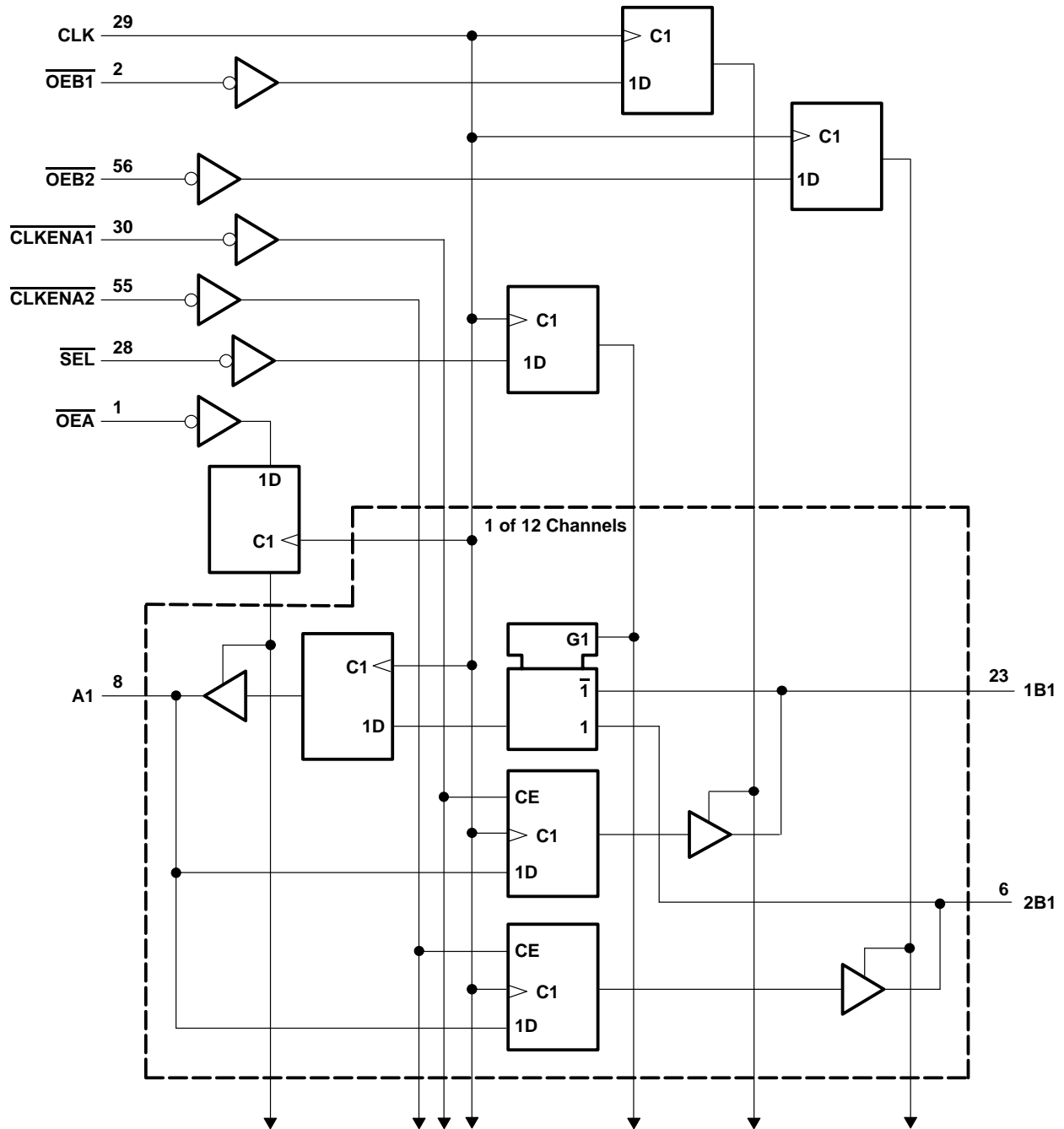
\dagger Output level before the indicated steady-state input conditions were established

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 4.6 V
Input voltage range, V_I : Except I/O ports (see Note 1)	–0.5 V to 4.6 V
I/O ports (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through each V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package	81°C/W
DGV package	86°C/W
DL package	74°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 4.6 V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2.3	3.6	V
V _{IH}	High-level input voltage	V _{CC} = 2.3 V to 2.7 V	1.7		V
		V _{CC} = 2.7 V to 3.6 V	2		
V _{IL}	Low-level input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	V
		V _{CC} = 2.7 V to 3.6 V		0.8	
V _I	Input voltage		0	V _{CC}	V
V _O	Output voltage		0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 2.3 V		−6	mA
		V _{CC} = 2.7 V		−8	
		V _{CC} = 3 V		−12	
I _{OL}	Low-level output current	V _{CC} = 2.3 V		6	mA
		V _{CC} = 2.7 V		8	
		V _{CC} = 3 V		12	
Δt/Δv	Input transition rise or fall rate		0	10	ns/V
T _A	Operating free-air temperature		−40	85	°C

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}	I _{OH} = −100 μA				2.3 V to 3.6 V	V _{CC} −0.2		V
	I _{OH} = −4 mA	V _{IH} = 1.7 V			2.3 V	1.9		
		V _{IH} = 2 V			2.7 V	2.2		
	I _{OH} = −6 mA	V _{IH} = 1.7 V			2.3 V	1.7		
		V _{IH} = 2 V			3 V	2.4		
	I _{OH} = −8 mA,		V _{IH} = 2 V			2.7 V	2	
I _{OH} = −12 mA,		V _{IH} = 2 V			3 V	2		
V _{OL}	I _{OL} = 100 μA				2.3 V to 3.6 V	0.2		V
	I _{OL} = 4 mA	V _{IL} = 0.7 V			2.3 V	0.4		
		V _{IL} = 0.8 V			2.7 V	0.4		
	I _{OL} = 6 mA	V _{IL} = 0.7 V			2.3 V	0.55		
		V _{IL} = 0.8 V			3 V	0.55		
	I _{OL} = 8 mA,		V _{IL} = 0.8 V			2.7 V	0.6	
I _{OL} = 12 mA,		V _{IL} = 0.8 V			3 V	0.8		
I _I	V _I = V _{CC} or GND				3.6 V	±5		μA
I _I (hold)	V _I = 0.7 V		2.3 V		45		μA	
	V _I = 1.7 V				−45			
	V _I = 0.8 V		3 V		75			
	V _I = 2 V				−75			
	V _I = 0 to 3.6 V‡		3.6 V		±500			
I _{OZ} §	V _O = V _{CC} or GND				3.6 V	±10		μA
I _{CC}	V _I = V _{CC} or GND, I _O = 0				3.6 V	40		μA
ΔI _{CC}		One input at V _{CC} − 0.6 V, Other inputs at V _{CC} or GND		3 V to 3.6 V		750		μA
C _i	Control inputs	V _I = V _{CC} or GND		3.3 V		5		pF
C _{io}	A or B ports	V _O = V _{CC} or GND		3.3 V		8.5		pF

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ For I/O ports, the parameter I_{OZ} includes the input leakage current.



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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

		$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.15\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency	0	95	0	115	0	135	0	135	MHz
t_w	Pulse duration, CLK high or low	5.2		4.3		3.3		3.3		ns
t_{su}	A data before CLK \uparrow	1.4		1.4		0.9		1		ns
	B data before CLK \uparrow	1.6		1.5		1		1.1		
	$\overline{\text{SEL}}$ before CLK \uparrow	0.8		1.1		1.3		1.3		
	$\overline{\text{CLKENA1}}$ or $\overline{\text{CLKENA2}}$ before CLK \uparrow	0.8		1		0.7		0.8		
	$\overline{\text{OE}}$ before CLK \uparrow	1.7		1.6		1.1		1.2		
t_h	A data after CLK \uparrow	0.9		0.9		1.1		1.2		ns
	B data after CLK \uparrow	0.8		0.6		0.8		1		
	$\overline{\text{SEL}}$ after CLK \uparrow	1.1		0.8		1.6		1.7		
	$\overline{\text{CLKENA1}}$ or $\overline{\text{CLKENA2}}$ after CLK \uparrow	1.4		1		1.4		1.6		
	$\overline{\text{OE}}$ after CLK \uparrow	0.9		0.8		1		1.2		

switching characteristics over recommended operating free-air temperature range, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.15\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}			95		115		135		135		MHz
t_{pd}	CLK	B	2.3	7.7	6.9		2.3	5.6	2.2	5.8	ns
		A	1.9	6.4	5.8		2	5	2	5.2	
t_{en}	CLK	B	2.5	7.7	6.9		2.3	5.6	2.3	5.8	ns
		A	2.2	6.7	6		2.1	5.2	2.1	5.3	
t_{dis}	CLK	B	3.3	8.1	6.7		2.3	5.8	2.4	6	ns
		A	2.7	8	6.2		2.2	5.9	2.1	6	

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER			TEST CONDITIONS		$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$	$V_{CC} = 3.3\text{ V}$ $\pm 0.15\text{ V}$	UNIT
					TYP	TYP	
C_{pd}	Power dissipation capacitance	Outputs enabled	$C_L = 0$, $f = 10\text{ MHz}$		142	172	pF
		Outputs disabled			115	129	



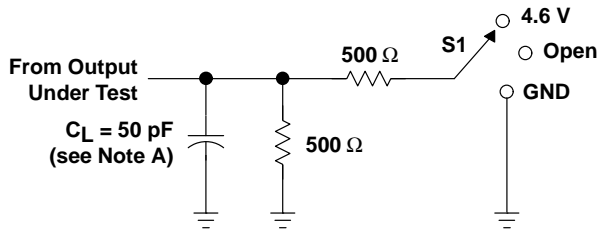
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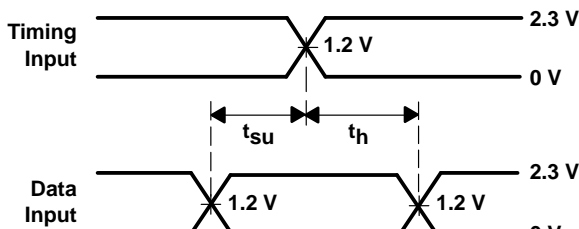
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$

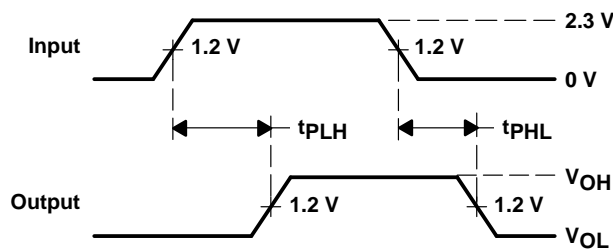


LOAD CIRCUIT

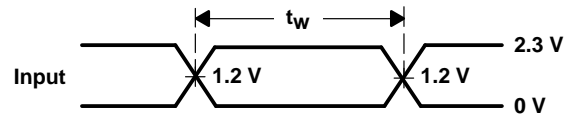
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	4.6 V
t_{PHZ}/t_{PZH}	GND



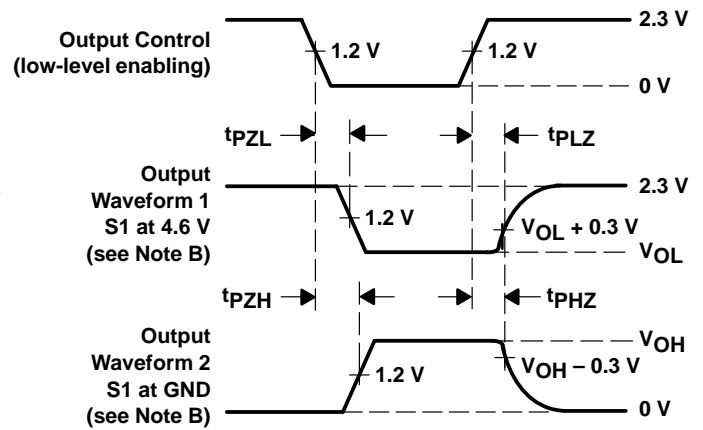
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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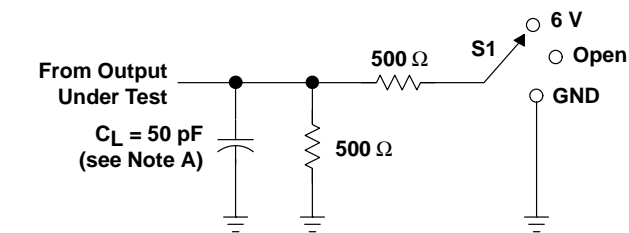
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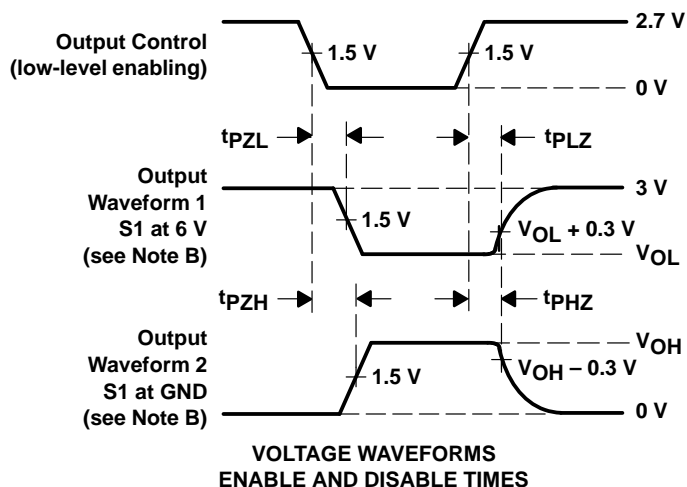
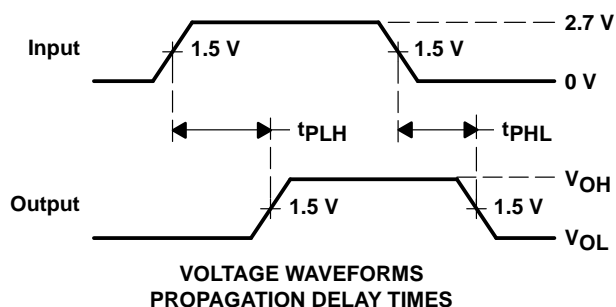
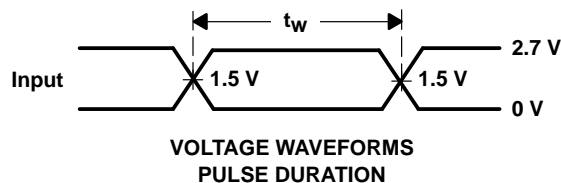
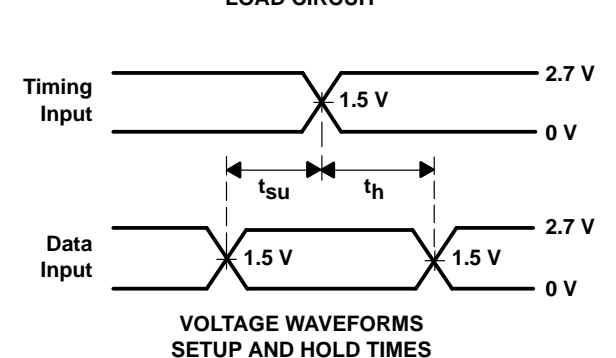
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.7\text{ V AND } 3.3\text{ V} \pm 0.3\text{ V}$



LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND



- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
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 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

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